

Specifications

Architecture	
Physical	Dimensions Double module, full-size Width: 5.85" (148.5 mm) Depth 7.11" (180.6 mm)
Type	AMC FPGA XCVU13P
Standards	
AMC	Type AMC.0, AMC.1, AMC.2 and AMC.3
Module Management	IPMI IPMI v2.0
PCIe (see option F)	Lanes Via MUX: "Dual x4 (Tongue 1) and x8 (Tongue 2)" or "x16 (Tongue 2)"
Configuration	
Power	AMC584 TBD W (application specific)
Environmental	Temperature See Ordering Options and Environmental Spec Sheet Storage Temperature: -40° to +85°C Vibration Operating 9.8 m/s ² (1G), 5 to 500 Hz on each axis Shock Operating 30G on each axis Relative Humidity 5 to 95% non-condensing
Front Panel	Interface Connectors QSFP28 JTAG Dual micro USB for RS-232 (management and payload) LEDs IPMI management control Debug (user defined) LED Mechanical Hot-swap ejector handle
Software Support	Operating System Independent
Other	
MTBF	MIL Hand book 217-F@ TBD hrs
Certifications	Designed to meet FCC, CE and UL certifications, where applicable
Standards	VadaTech is certified to both the ISO9001:2000 and AS9100B:2004 standards
Warranty	Two (2) years, see VadaTech Terms and Conditions

INTEGRATION SERVICES AND APPLICATION-READY PLATFORMS

VadaTech has a full ecosystem of OpenVPX, ATCA and MTCA products including chassis platforms, shelf managers, AMC modules, Switch and Payload Boards, Rear Transition Modules (RTMs), Power Modules, and more. The company also offers integration services as well as pre-configured Application-Ready Platforms. Please contact VadaTech Sales for more information.